



TFW

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q68281

Hui ZHONG, et al.

Appln. No.: 10/049,270

Group Art Unit: 2841

Confirmation No.: 9445

Examiner: Tuan T. Dinh

Filed: February 11, 2002

For: MULTILAYERED PRINTED CIRCUIT BOARD, SOLDER RESIST COMPOSITION,
MULTILAYERED PRINTED CIRCUIT BOARD MANUFACTURING METHOD, AND
SEMICONDUCTOR DEVICE

AMENDMENT UNDER 37 C.F.R. § 1.111

MAIL STOP AMENDMENT

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated February 23, 2006, please amend the above-identified application as follows on the accompanying pages.

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